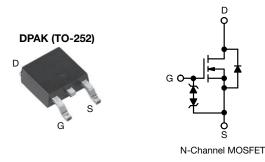
## SiHD5N80AE

**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	1.17			
Q <sub>g</sub> max. (nC)	16.5				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	6				
Configuration	Single				

### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD5N80AE-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	800	v		
Gate-source voltage			V <sub>GS</sub>	± 30	V		
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		4.4			
	VGS at 10 V	T <sub>C</sub> = 100 °C	l <sub>D</sub>	2.8	А		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	7			
Linear derating factor				0.5	W/°C		
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	17	mJ		
Maximum power dissipation			PD	62.5	W		
Operating junction and storage temperature range	ge		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope		T <sub>J</sub> = 125 °C	70				
Reverse diode dv/dt <sup>d</sup>		dv/dt	0.3	V/ns			
Soldering recommendations (peak temperature)	с	For 10 s		260	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.1 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C

S20-0945-Rev. A, 14-Dec-2020

1

Document Number: 92374



COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS									
PARAMETER	SYMBOL	MAX.			UNIT					
Maximum junction-to-ambient	R <sub>thJA</sub>	62			00 MV					
Maximum junction-to-case (drain)	R <sub>thJC</sub>		°C/W							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)										
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT			
Static										
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	800	-	-	V			
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.8	-	V/°C			
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	: V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2	-	4	V			
Osta asura laskas		$V_{GS} = \pm 20 \text{ V}$		-	-	± 10	μA			
Gate-source leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 30 V		-	-	± 50				
		V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	1				
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 640 V	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	10	μA			
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.5 A	-	1.17	1.35	Ω			
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 2 A	-	1.2	-	S			
Dynamic	•	•				•	•			
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	321	-	pF			
Output capacitance	C <sub>oss</sub>			-	20	-				
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-				
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	14	-				
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	71	-				
Total gate charge	Qg			-	11	16.5				
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 2 A, V <sub>DS</sub> = 640 V		3	-	nC			
Gate-drain charge	Q <sub>gd</sub>			-	6	-	1			
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}=640~V,~I_{D}=2~A, \label{eq:V_DD} V_{GS}=10~V,~R_{g}=9.1~\Omega$		-	12	24	ns			
Rise time	t <sub>r</sub>			-	8	16				
Turn-off delay time	t <sub>d(off)</sub>			-	10	20				
Fall time	t <sub>f</sub>			-	28	56				
Gate input resistance	Rg	f = 1 MHz, open drain		1.6	3.2	6.4	Ω			
Drain-Source Body Diode Characterist										
Continuous source-drain diode current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.4	A			
Pulsed diode forward current	I <sub>SM</sub>			-	-	7				
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 2 A, V <sub>GS</sub> = 0 V		-	-	1.2	V			
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 2 \text{ A},$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	267	534	ns			
Reverse recovery charge	Q <sub>rr</sub>			-	1.2	2.4	μC			
Reverse recovery current	I <sub>RRM</sub>			-	7.5	-	A			
•	1			1	1	I	I			

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 



# SiHD5N80AE

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

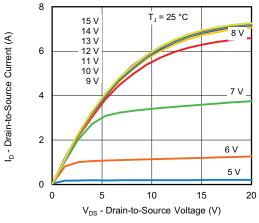


Fig. 1 - Typical Output Characteristics

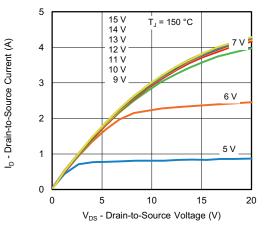


Fig. 2 - Typical Output Characteristics

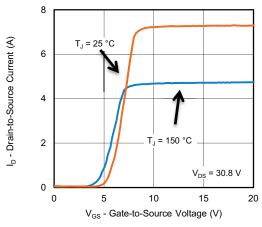


Fig. 3 - Typical Transfer Characteristics

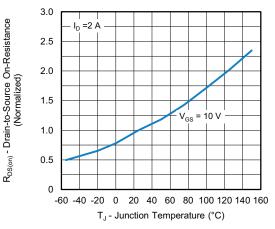


Fig. 4 - Normalized On-Resistance vs. Temperature

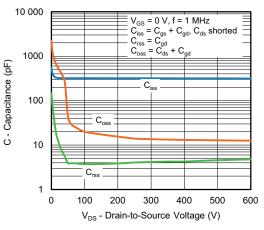
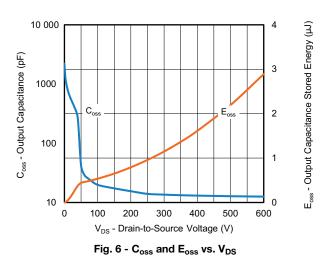


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S20-0945-Rev. A, 14-Dec-2020

**3** For technical questions, contact: <u>hvm@vishay.com</u>

Document Number: 92374

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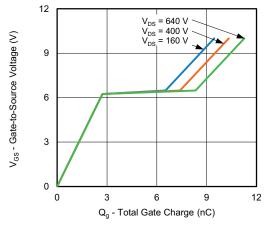


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

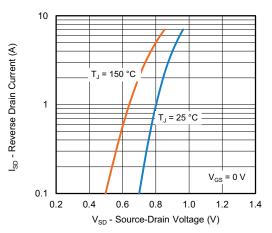


Fig. 8 - Typical Source-Drain Diode Forward Voltage

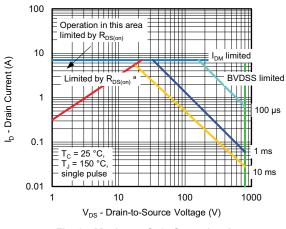


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4

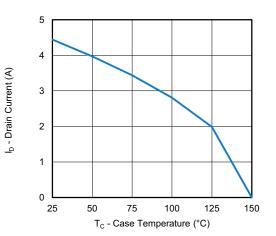


Fig. 10 - Maximum Drain Current vs. Case Temperature

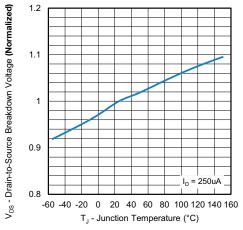


Fig. 11 - Normalized Breakdown Voltage vs. Temperature



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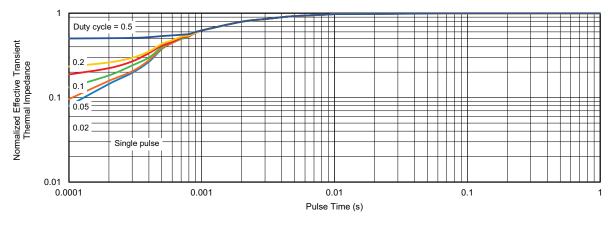


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

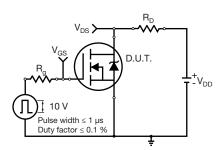


Fig. 13 - Switching Time Test Circuit

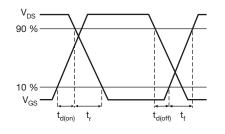


Fig. 14 - Switching Time Waveforms

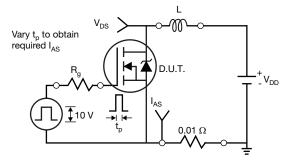


Fig. 15 - Unclamped Inductive Test Circuit

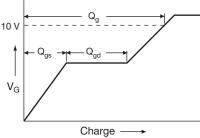
S20-0945-Rev. A, 14-Dec-2020

5



I<sub>AS</sub> \_\_\_\_\_Fig. 16 - Unclamped Inductive Waveforms

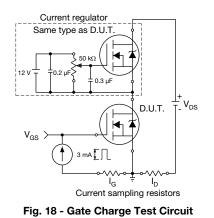
V<sub>DS</sub>



'n

 $V_{DD}$ 

Fig. 17 - Basic Gate Charge Waveform



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#### Peak Diode Recovery dv/dt Test Circuit

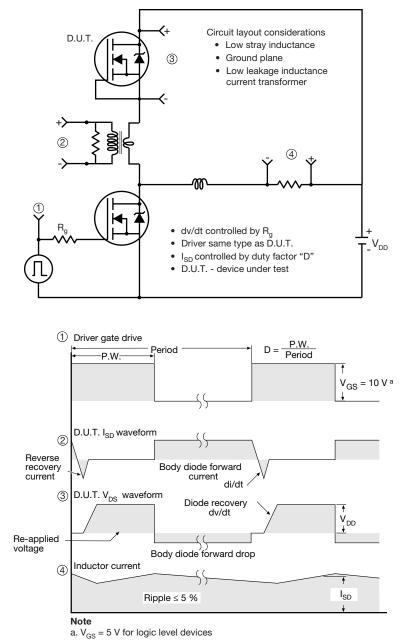


Fig. 19 - For N-Channel

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